FMV08N60S1

http://www.fujielectric.com/products/semiconductor/

FUJI POWER MOSFET

Super J MOS® S1 series

N-Channel enhancement mode power MOSFET

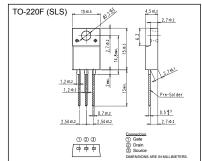
Features

Pb-free lead terminal RoHS compliant

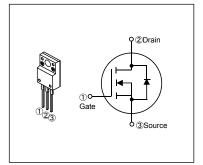
Applications

For switching

Outline Drawings [mm]



Equivalent circuit schematic



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Drain Current	lo ~ RST	DD 48	Α	Tc=25°C Note*1
Continuous Drain Current		1000年5年月日	Α	Tc=100°C Note*1
Pulsed Drain Current	lop	124 4	A	
Gate-Source Voltage	VGS	5 V±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	TAR J	altict	Α	Note *2
Non-Repetitive Maximum Avalanche Energy	the PI	249.6 - 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	す。 mJ	Note *3
Maximum Drain-Source dV/dt	dVos/dt _= t	顔し、50	kV/μs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt/2000	ignin915	kV/μs	Note *4
Peak Diode Recovery -di/dt	Sailyt - ON OC-	100	A/µs	Note *5
Maximum Power Dissipation Operating and Storage Temperature range	101 1.	2.16	W	T _a =25°C
	FD	25	VV	Tc=25°C
Onereting and Starger Tamporal Note: DO	Tch	150	°C	
Operating and Storage Temperature range	T _{stg}	-55 to +150	°C	
Isolation Voltage	Viso	2	kVrms	t=60sec, f=60Hz

Note *1 : Limited by maximum channel temperature.

Note *2 : Tch≤150°C, See Fig.1 and Fig.2

Note *2: InhS150 °C, See Fig.1 and Fig.2

Note *3: Starting Tch=25°C, Ias=1.5A, L=203mH, Vdd=60V, Rd=50Ω, See Fig.1 and Fig.2

Eas limited by maximum channel temperature and avalanche current.

Note *4: Ir≤-Id, -di/dt=100A/µs, Vdd≤400V, Vdeak≤BVdss, Tch≤150°C.

Note *5: Ir≤-Id, dV/dt=15kV/µs, Vdd≤400V, Vdeak≤BVdss, Tch≤150°C.

■ Electrical Characteristics at T_c=25°C (unless otherwise specified) Static Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250µA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =250µA V _{DS} =V _{GS}		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	Ipss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	μΑ
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	-	250	
Gate-Source Leakage Current	I _{GSS}	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =4A V _{GS} =10V		-	0.399	0.47	Ω
Gate resistance	R _G	f=1MHz, open drain		-	2.9	-	Ω

Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =4A V _{DS} =25V	3.5	7.5	-	S
Input Capacitance	Ciss	V _{DS} =10V	-	620	-	
Output Capacitance	Coss	V _{GS} =0V	-	1340	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	120	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0480V	-	48	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0480V ID=constant	-	140	-	
Turn-On Time	t _{d(on)}		-	9.5	-	
Turn-On Time	t r	V _{DD} =400V, V _{GS} =10V/0V	-	29	-	ns
Turn-Off Time	t _{d(off)}	I₀=4A, R₀=30Ω See Fig.3 and Fig.4	-	75	-	
Turni-On Time	t _f		-	16	-	
Total Gate Charge	Q _G	V _{DD} =480V, I _D =8A V _{GS} =10V See Fig.5	-	25	-	
Gate-Source Charge	Q _{GS}		-	7.5	-	nC
Gate-Drain Charge	Q _{GD}		-	6	-	IIC
Drain-Source crossover Charge	Qsw		-	5	-	

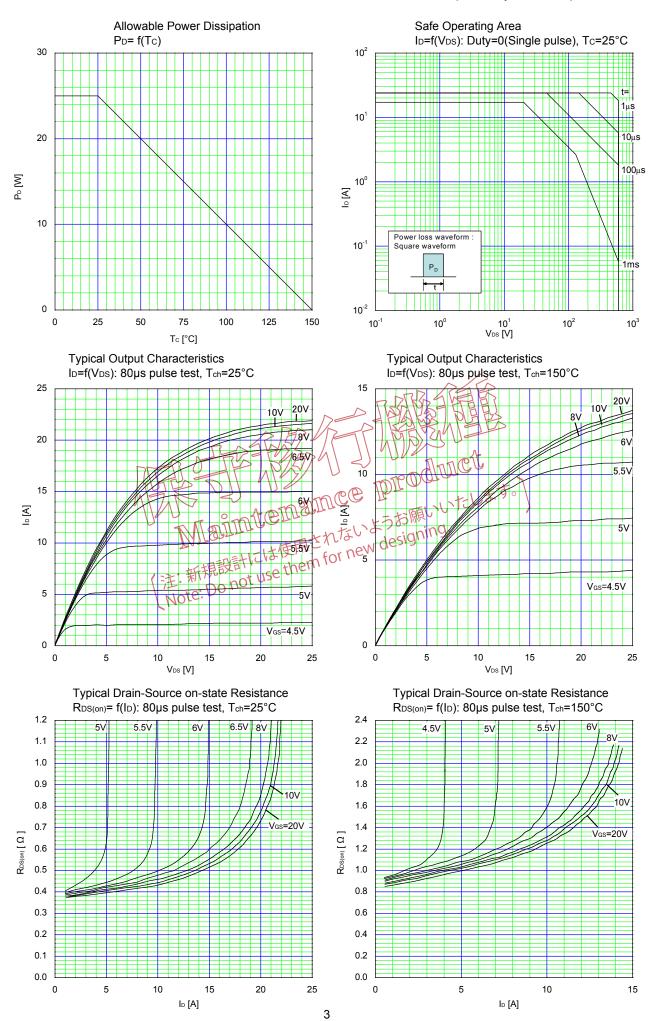
Note *6 : $C_{0(er)}$ is a fixed capacitance that gives the same stored energy as C_{058} while V_{DS} is rising from 0 to 80% BVoss. Note *7 : $C_{0(tr)}$ is a fixed capacitance that gives the same charging times as C_{058} while V_{DS} is rising from 0 to 80% BVoss.

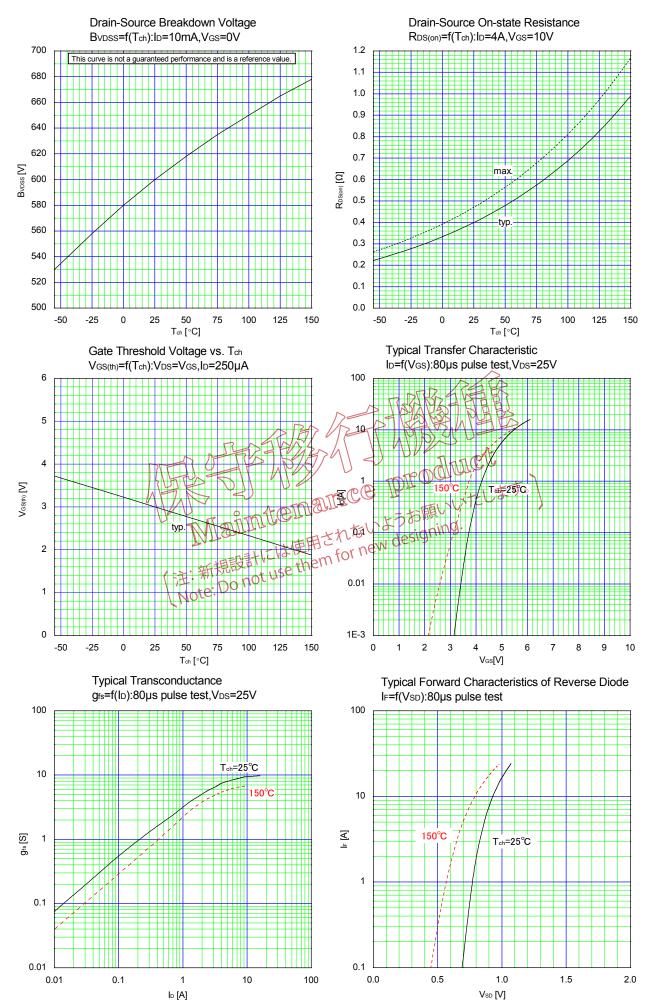
• Reverse Diode

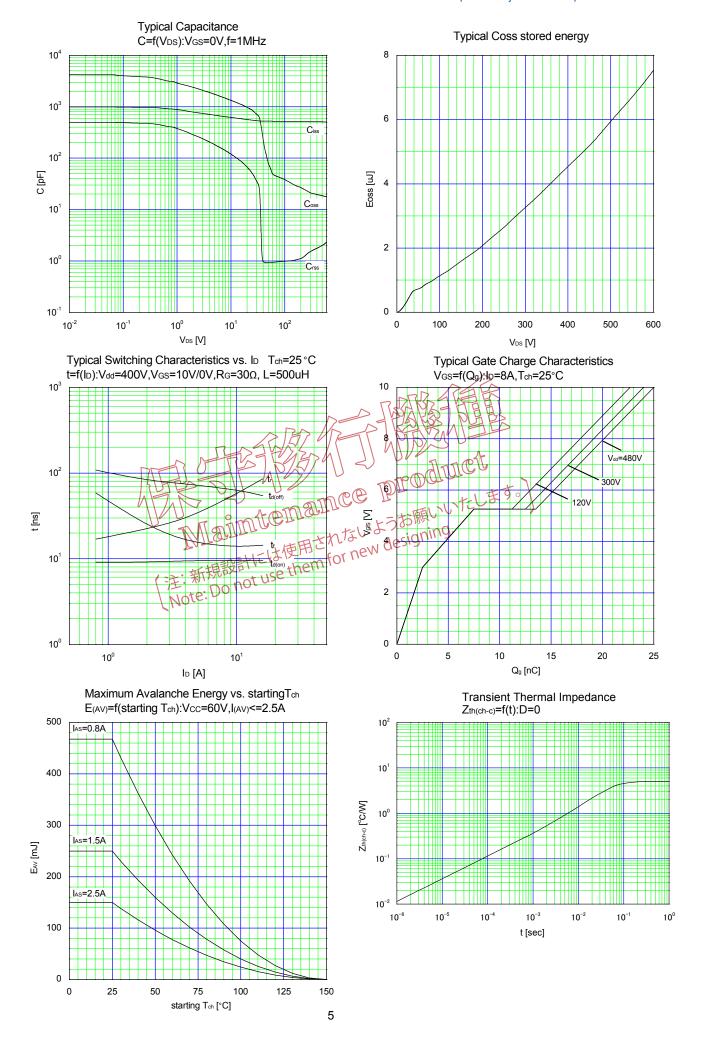
Reverse Diode		D DTK		À		
Description	Symbol	Conditions	P. min. S	typ.	max.	Unit
Avalanche Capability	lav R	L=43.9mH, V _o =25°C See Fig. 1 and Fig.2	2.5	-	-	Α
Diode Forward On-Voltage	No.	It=8A Vas=0V Th=25°C	dimic a	± 0.9	1.35	V
Reverse Recovery Time		IF=8A-V@+400V	white	285	-	ns
Reverse Recovery Charge	O MI ar	Vosion=short, Vosion=100/10V design	- [[19·	3.2	-	μC
Peak Reverse Recovery Current	产。新規部 产。新規部	I= 8A V	-	20	-	Α
	Note.					

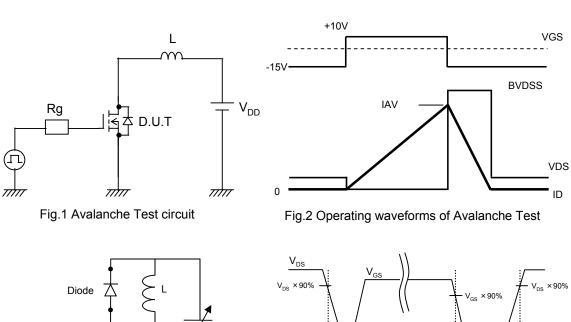
■ Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	5.0	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	58	°C/W









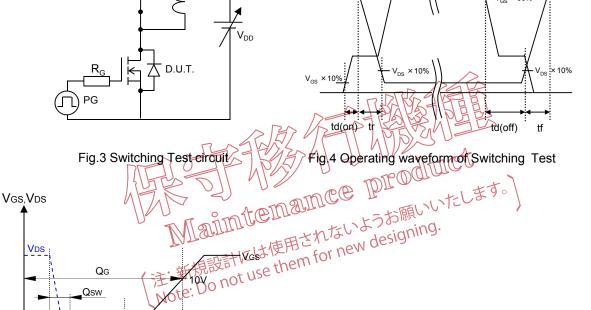


Fig.5 Operating waveform of Gate charge Test

---- Qg

Qsw

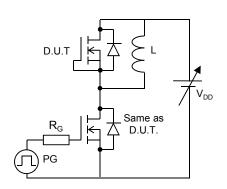


Fig.6 Reverse recovery Test circuit

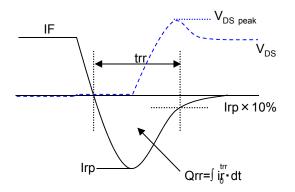
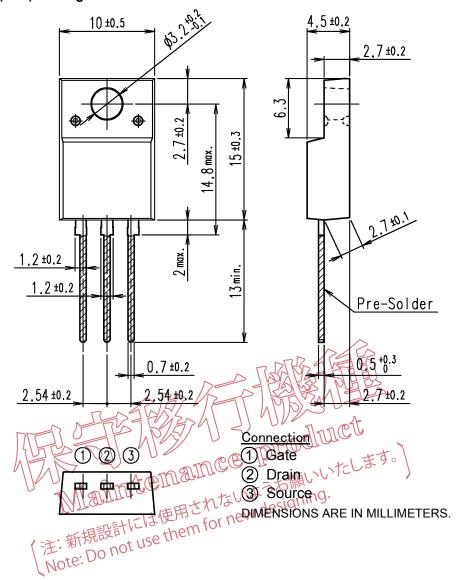
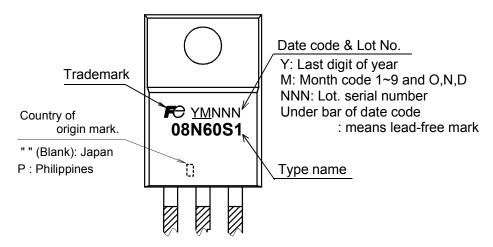


Fig.7 Operating waveform of Reverse recovery Test

Outview: TO-220F (SLS) Package



Marking



^{*} The font (font type,size) and the trademark-size might be actually different.

http://www.fujielectric.com/products/semiconductor/

WARNING

1. This Catalog contains the product specifications, characteristics, data materials, and structures as of October 2015. The contents are subject to change without notice for specification changes or other reasons. When using a product listed in this Catalog, be sur to obtain the latest specifications

sur to obtain the latest specifications.

2. All applications described in this Catalog exemplify the use of Full's products for your reference only. No right or license, either express or implied, under any patent, copyright, trade secret or other intellectual property right owned by Fuji Electric Co., Ltd. is (or shall be deemed) granted. Fuji Electric Co., Ltd., makes no representation or warranty, whether express or implied, relating to the infringement or alleged infringement of other's intellectual property rights Which may arise from the use of the applications described herein.

3. Although Fuji Electric Co., Ltd. is enhancing product quality and reliability, a small percentage of semiconductor products may become faulty. When using Fuji Electric semiconductor products in your equipment, you are requested to take adequate safety measures to prevent the equipment from causing a physical injury, fire, or other problem if any of the products become faulty. It is recommended to make your design failsafe, flame retardant, and free of malfunction.

- 4. The products introduced in this Catalog are intended for use in the following electronic and electrical equipment which has normal reliability requirements.
 - Computers
- · OA equipment
- Communications equipment (terminal devices)
- · Measurement equipment

- Machine tools
- Audiovisual equipment
- Electrical home appliances
- Personal equipment Industrial robots etc.
- 5. If you need to use a product in this Catalog for equipment requiring higher reliability than normal, such as for the equipment listed below, it is imperative to contact Fuji Electric Co., Ltd. to obtain prior approval. When using these products for such equipment, take adequate measures such as a backup system to prevent the equipment from malfunctioning even if a Fuji's product incorporated in the equipment becomes faulty.
- Transportation equipment (mounted on cars and ships)
- Trunk communications equipment

Traffic-signal control equipment

- Gas leakage detectors with an auto-shut-off feature
- Emergency equipment for responding to disasters and anti-burglary devices
- · Safety devices
- 6. Do not use products in this Catalog for the equipment requiring strict reliability such as the following and equivalents to strategic equipment (without limitation).
 - Space equipment

- Aeronautic equipment
- · Nuclear control equipment

- Submarine repeater equipment
- 7. Copyright ©1996-2015 by Fuji Electric Co., Ltd. All rights reserved. No part of this Catalog may be reproduced in any form or by any means without the express permission of Fuji Electric Co., Ltd.
- 8. If you have any question about any portion in this Catalog, ask Fuji Electric Co., Ltd. or its sales agents before using the product. Neither Fuji Electric Co., Ltd. nor its agents shall be liable for any injury caused by any use of the products not in accordance with instructions set forth herein.